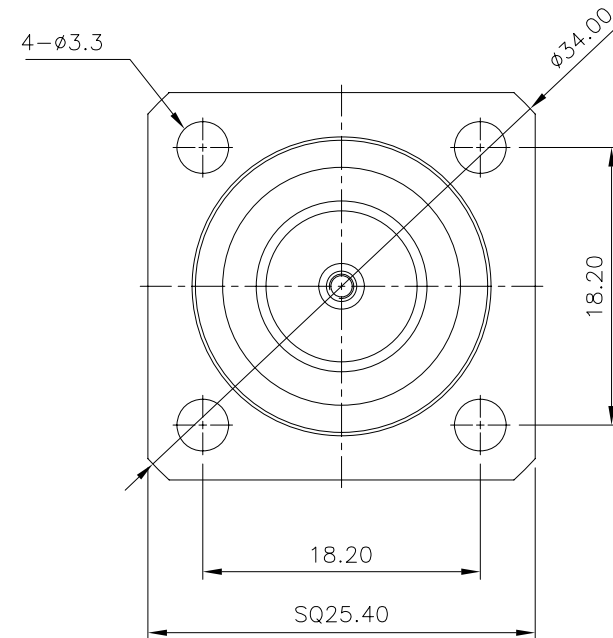
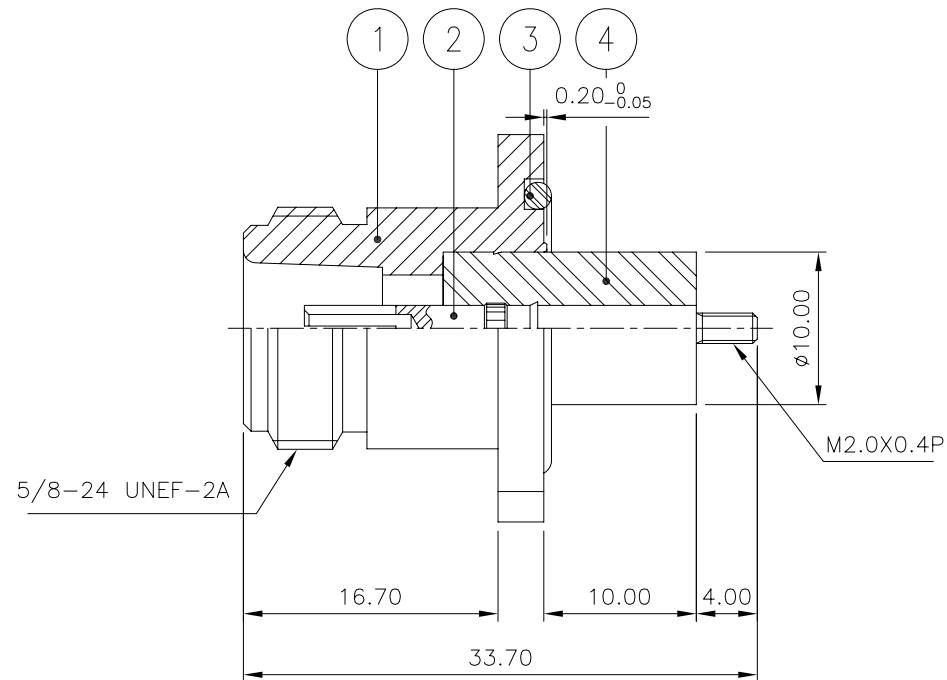


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	M.H.SONG	I.C.KIM	2014.06.26.
1	[설변No.201409-0001] 신뢰성 향상 (나사부 조립 후 회전 방지-널링 추가)	E.H.KIM	I.C.KIM	2014.09.01.



4	INSULATOR	1	TEFLON		DIN02408-N/1
3	GASKET	1	Silicone Rub		DGK00045-N/1
2	CONTACT	1	BeCu	Silver 3.0μm min.	DCT03154-5/1
1	BODY	1	MBsBD	SUCO 3.0μm min.	DBD03606-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2014. 09. 01.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY	-	KJ COMTECH CO.,LTD. TITLE N50 SOLDER END JS-4H
		DRAWN BY	M.H.SONG	
FINISH		SCALE	UNIT	A4 DWG NO. CN03247-7/1 REVISION 1 SHEET 1 of 1
		2/1	mm	